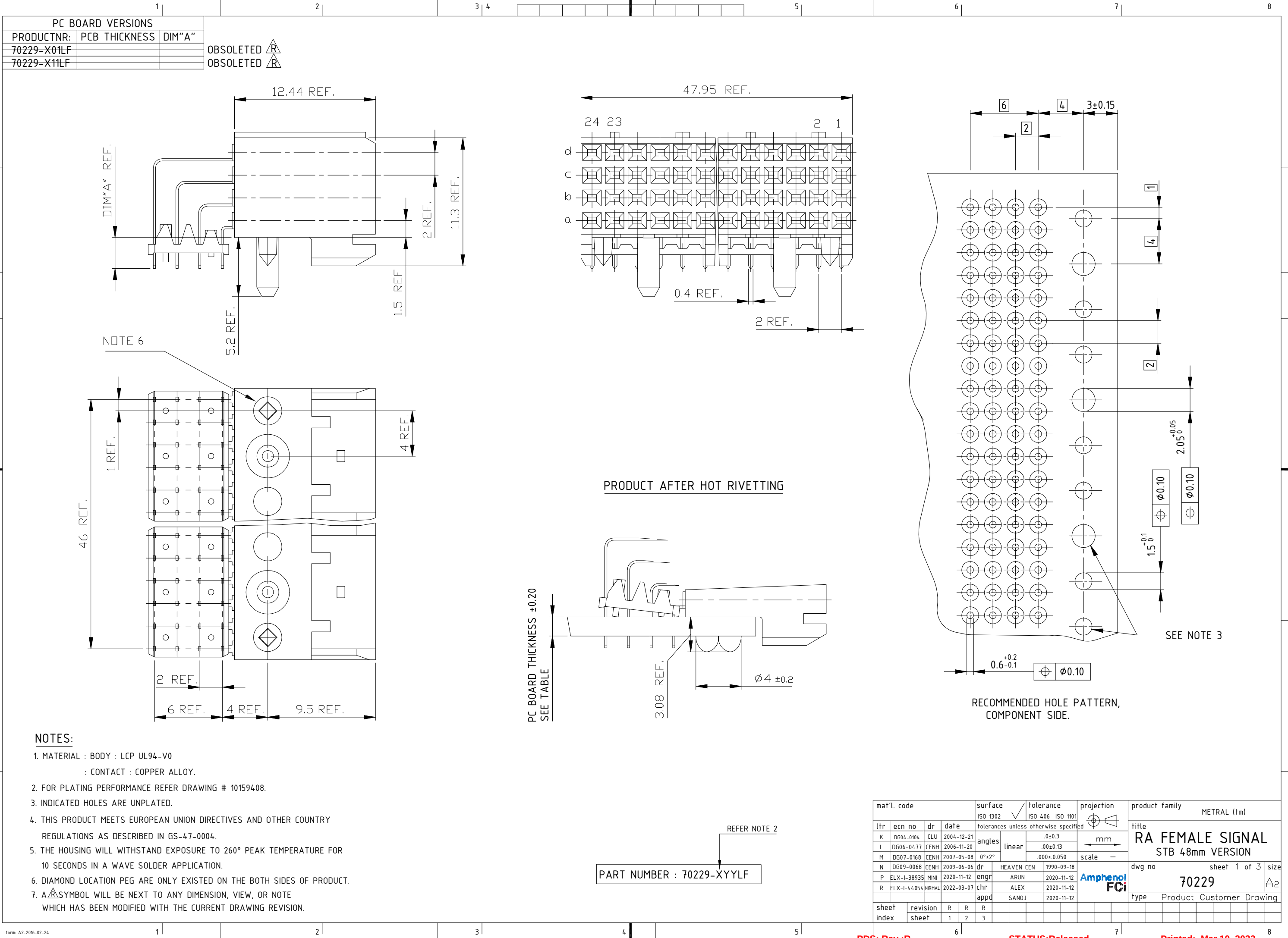
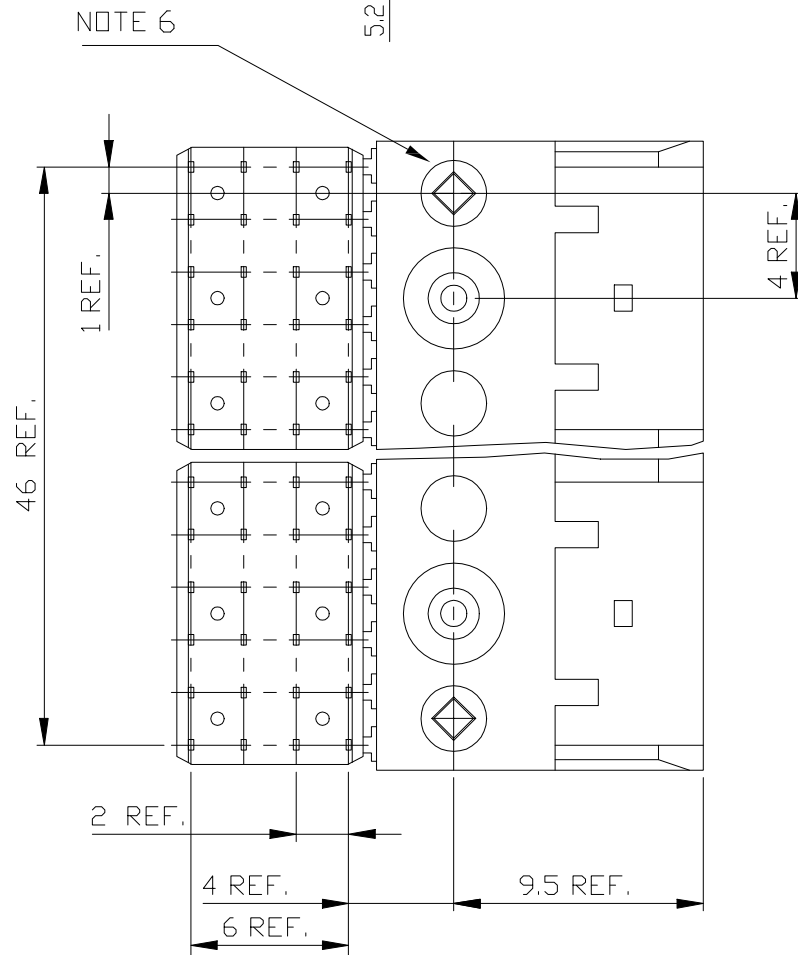
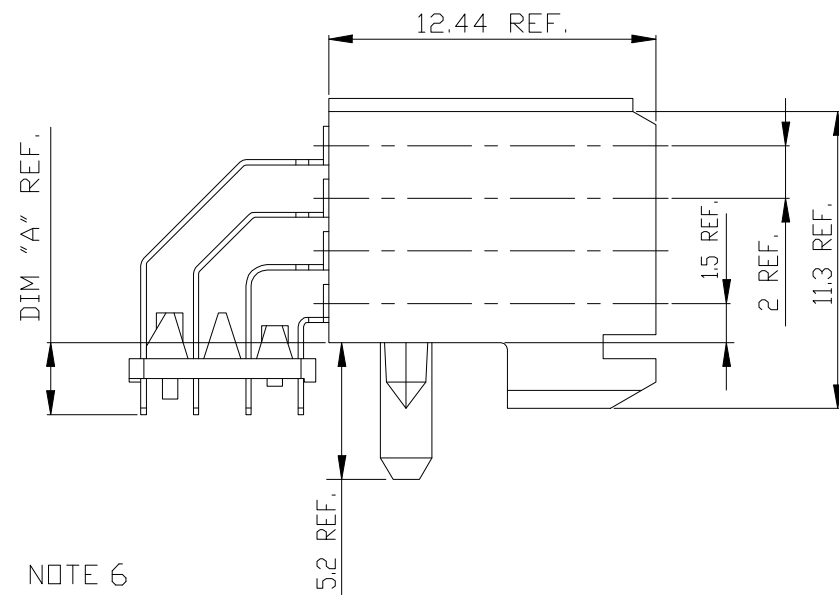


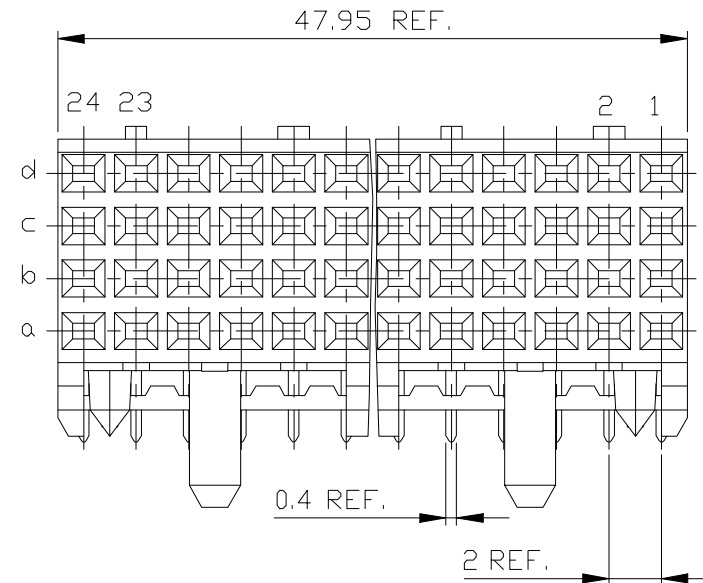


PC BOARD VERSIONS		
PRODUCTNR:	PCB THICKNESS	DIM "A"
70229-X03LF	1.6	2.90
70229-X13LF	2.4	3.53

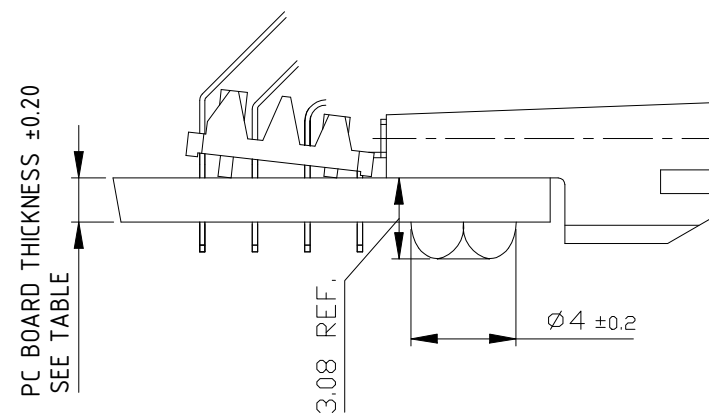


NOTES:

1. MATERIAL : BODY : LCP UL94-V0
: CONTACT : COPPER ALLOY.
2. FOR PLATING PERFORMANCE REFER DRAWING # 10159408.
3. INDICATED HOLES ARE UNPLATED.
4. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004.
5. THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION.
6. DIAMOND LOCATION PEG ARE ONLY EXISTED ON THE BOTH SIDES OF PRODUCT.
7. A Δ SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.

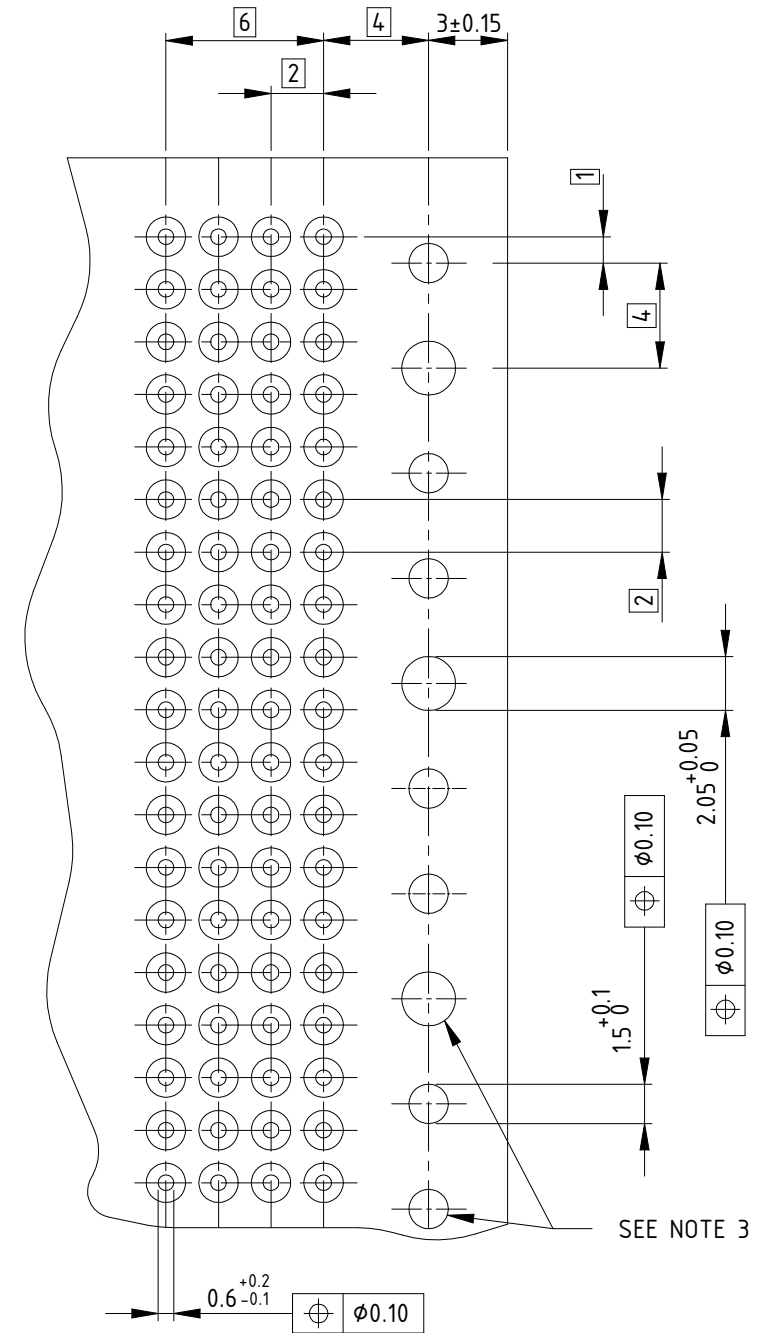


PRODUCT AFTER HOT RIVETTING



PART NUMBER : 70229-XYLLF

REFER NOTE 2

RECOMMENDED HOLE PATTERN,
COMPONENT SIDE.

mat'l. code				surface	ISO 1302	tolerance	ISO 406	ISO 1101	projection	product family	METRAL (tm)
lfr	ecn no	dr	date	tolerances unless otherwise specified	angles	linear	0.03	0.03	mm	title	RA FEMALE SIGNAL
K	DG04-0104	CLU	2004-12-21							STB 48mm VERSION	
L	DG06-0477	CENH	2006-11-20								
M	DG07-0168	CENH	2007-05-08	0°±2°			0.00±0.050		scale	dwg no	70229
N	DG09-0068	CENH	2009-06-06		dr	HEAVEN CEN	1990-09-18			sheet 3 of 3	size
P	ELX-I-38935	MINI	2020-11-12		enr	ARUN	2020-11-12				A2
R	ELX-I-44054	NIRHAL	2022-03-07		chr	ALEX	2020-11-12				
					appd	SANOJ	2020-11-12				
sheet	revision	R	R	R						type	Product Customer Drawing
index	sheet	1	2	3							